



# PSpice Model Resistor-Equipped Transistor (RET) Nexperia PDTC114EU

#### **Model Information**

Model	A macro model		
Call Name	MDC_PDTC114EU_PS		
Pin Assign	1:BASE 2:EMITTER 3:COLLECTOR		
File List	Model Library MDC_PDTC114EU_PS.lib		
	Model Report MDC_PDTC114EU_PS.pdf(this file)		

**Verified Simulator Version** 

PSpice v17.2

Note

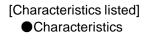
#### References

The information which was used for modeling is as follow:

[Data Sheet]

Date/Version			
Product name			
Company name			

Rev. 12 — 21 December 2011 PDTC114E\_SER Nexperia B.V.



VCEsat-IC hFE-IC Cob-VR VIon-IC VIoff-IC

#### Simulation Condition

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

Item	Condition	Unit
Temperature	-40,25,100	deg C



O:Implemented

× : Not Implemented

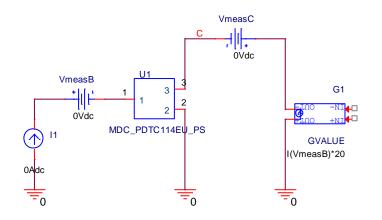
		— : Not applicable
Model Functions Table	RANK=1	. Not applicable
Functions	RANK	Implemented
VIN(on)-Iout(Temp)	1	0
Iout-VIN(off)(Temp)	1	0
Iout-Vo-Iin	1	—
DC_Current_Gain-Iout	1	0
VOUT(on)-Iout(Temp)	1	—
VOUT(sat)-Iin(Temp)	1	0
Capacitance	1	0
Transition Frequency	1	_
Switching(Typ.)	1	_



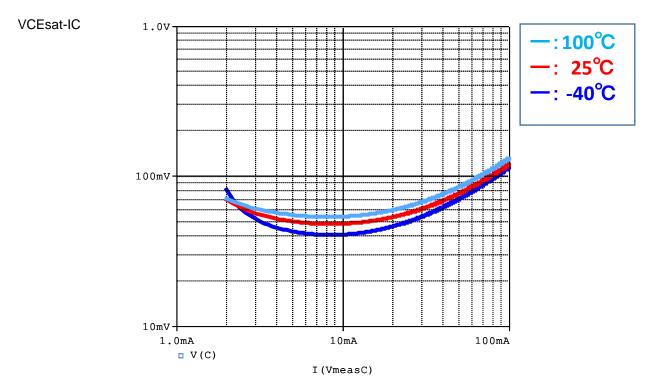


VCEsat-IC Testbench

### **Referred to Data Sheet**



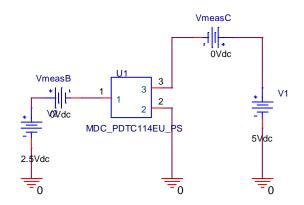
Simulation results are following. Explanatory notes -: simulated



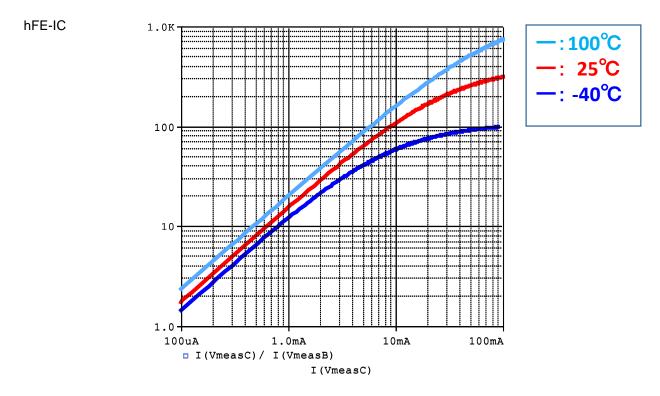


hFE-IC Testbench

### **Referred to Data Sheet**



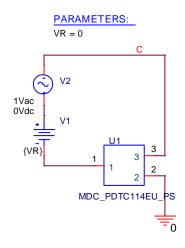
Simulation results are following. Explanatory notes -: simulated





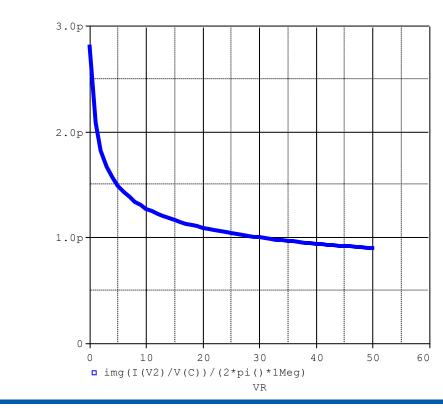
**Cob-VR Testbench** 

#### **Referred to Data Sheet**



#### Simulation results are following. Explanatory notes — : simulated

Cob-VR

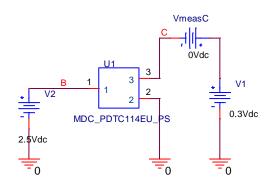


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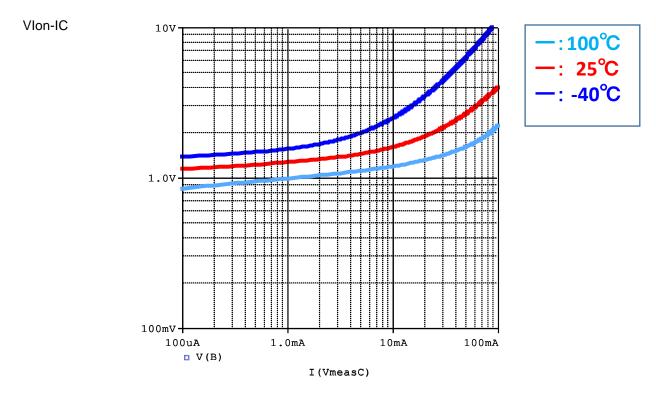


**Vion-IC Testbench** 

### **Referred to Data Sheet**



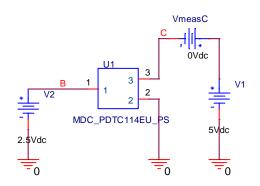
Simulation results are following. Explanatory notes — : simulated



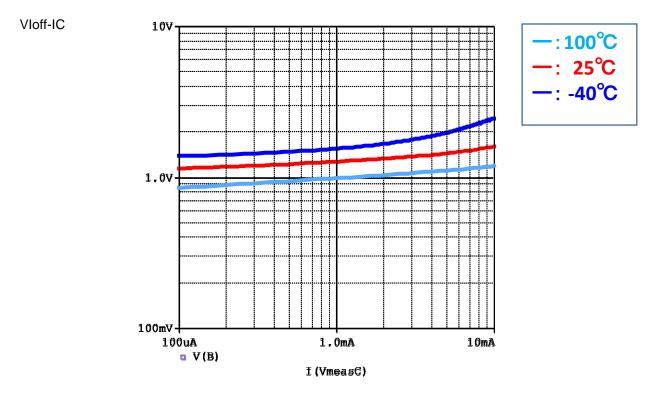


Vloff-IC Testbench

## **Referred to Data Sheet**



Simulation results are following. Explanatory notes -: simulated





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